



PATENT APPLICATION

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IN THE U.S. PATENT AND TRADEMARK OFFICE

May 12, 2011

Applicants: Atsushi YABE et al

For: ELECTROLESS COPPER PLATING METHOD

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Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RCE AMENDMENT

Sir:

Please amend the above-identified application as follows:
(Please see following pages.)